

# MOS FIELD EFFECT TRANSISTOR 2SK2140, 2SK2140-Z

#### SWITCHING N-CHANNEL POWER MOS FET INDUSTRIAL USE

#### **DESCRIPTION**

The 2SK2140, 2SK2140-Z is N-channel Power MOS Field Effect Transistor designed for high voltage switching applications.

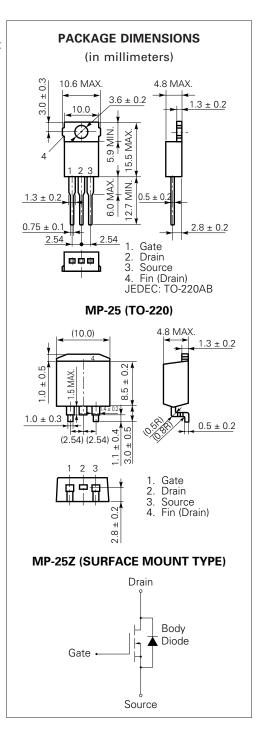
#### **FEATURES**

- Low On-state Resistance  $R_{DS(on)} = 1.5 \ \Omega \ MAX. \ (V_{GS} = 10 \ V, \ I_{D} = 3.5 \ A)$
- Low Ciss Ciss = 930 pF TYP.
- · High Avalanche Capability Ratings

#### ABSOLUTE MAXIMUM RATINGS (TA = 25 °C)

Drain to Source Voltage	$V_{\text{DSS}}$	600	V
Gate to Source Voltage	Vgss	±30	V
Drain Current (DC)	ID(DC)	±7.0	Α
Drain Current (pulse)*	ID(pulse	±28	Α
Total Power Dissipation (Tc = 25 °C)	P <sub>T1</sub>	75	W
Total Power Dissipation (T <sub>A</sub> = 25 °C)	P <sub>T2</sub>	1.5	W
Storage Temperature	$T_{\text{stg}}$	-55 to +150	°C
Channel Temperature	$T_ch$	150	°C
Single Avalanche Current**	las	7.0	Α
Single Avalanche Energy**	Eas	16.3	mJ

- \* PW  $\leq$  10  $\mu$ s, Duty Cycle  $\leq$  1 %
- \*\* Starting T<sub>ch</sub> = 25 °C, R<sub>G</sub> = 25  $\Omega$ , V<sub>GS</sub> = 20 V  $\rightarrow$  0



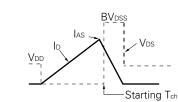


#### **ELECTRICAL CHARACTERISTICS (TA = 25 °C)**

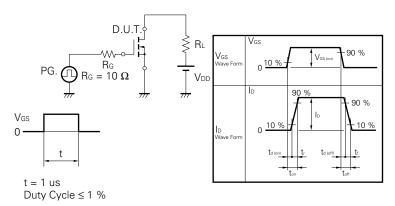
CHARACTERISTIC	SYMBOL	MIN.	TYP.	MAX.	UNIT	TEST CONDITIONS
Drain to Source On-state Resistance	RDS(on)		1.1	1.5	Ω	Vgs = 10 V, ID = 3.5 A
Gate to Source Cutoff Voltage	V <sub>GS(off)</sub>	2.5		3.5	V	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 1 mA
Forward Transfer Admittance	l y <sub>fs</sub> l	1.5			S	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 3.5 A
Drain Leakage Current	IDSS			100	μΑ	V <sub>DS</sub> = 600 V, V <sub>GS</sub> = 0
Gate to Source Leakage Current	Igss			±100	nA	$V_{GS} = \pm 30 \text{ V}, V_{DS} = 0$
Input Capacitance	Ciss		930		pF	V <sub>DS</sub> = 10 V
Output Capacitance	Coss		200		pF	V <sub>G</sub> S = 0
Reverse Transfer Capacitance	Crss		40		pF	f = 1 MHz
Turn-On Delay Time	td(on)		20		ns	V <sub>GS</sub> = 10 V
Rise Time	tr		12		ns	V <sub>DD</sub> = 150 V
Turn-Off Delay Time	td(off)		60		ns	$I_D$ = 3.5 A, $R_G$ = 10 $\Omega$
Fall Time	tf		12		ns	$R_L = 42.9 \Omega$
Total Gate Charge	QG		30		nC	V <sub>G</sub> S = 10 V
Gate to Source Charge	Qgs		6.0		nC	ID = 7.0 V
Gate to Drain Charge	Q <sub>GD</sub>		15		nC	V <sub>DD</sub> = 450 V
Diode Forward Voltage	V <sub>F(S-D)</sub>		1.0		V	IF = 7.0 A, VGS = 0
Reverse Recovery Time	trr		400		ns	IF = 7.0 A
Reverse Recovery Charge	Qrr		2.0		μC	$di/dt = 50 A/\mu s$

#### Test Circuit 1 Avalanche Capability

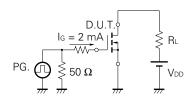
# $\begin{array}{c} \text{D.U.T.} \\ \text{RG} = 25 \Omega \\ \text{VGS} = 20 \rightarrow 0 \end{array}$



#### Test Circuit 2 Switching Time

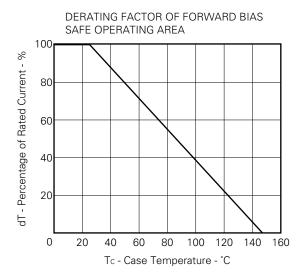


#### **Test Circuit 3 Gate Charge**

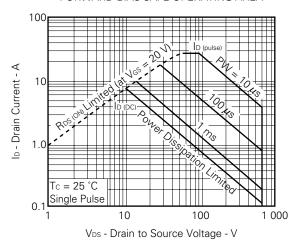


The application circuits and their parameters are for references only and are not intended for use in actual design-in's.

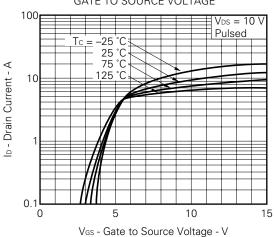
#### TYPICAL CHARACTERISTICS (TA = 25 °C)

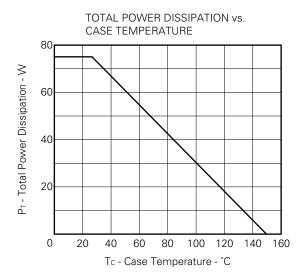


#### FORWARD BIAS SAFE OPERATING AREA

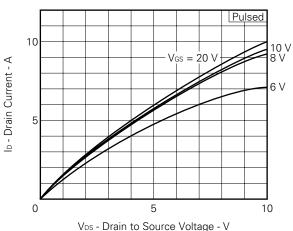


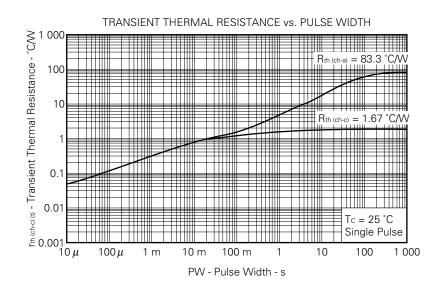
### DRAIN CURRENT vs. GATE TO SOURCE VOLTAGE

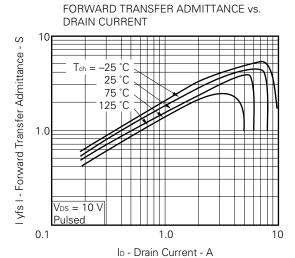


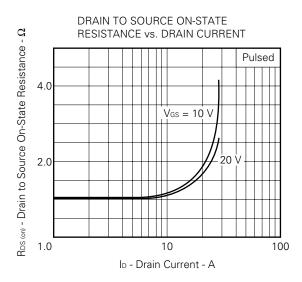


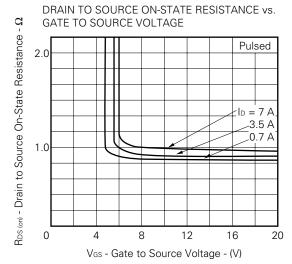
#### DRAIN CURRENT vs. DRAIN TO SOURCE VOLTAGE

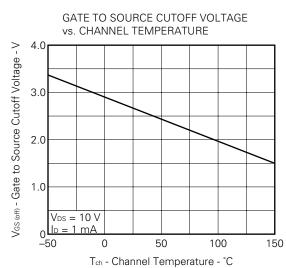


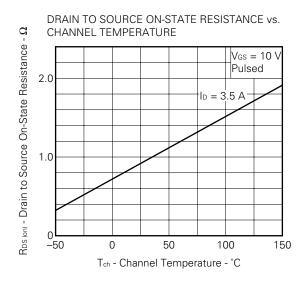


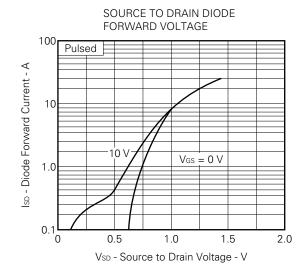


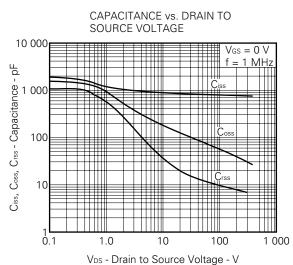


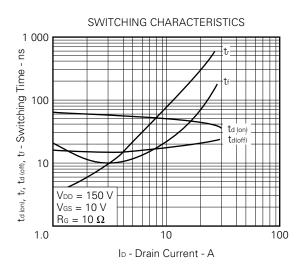


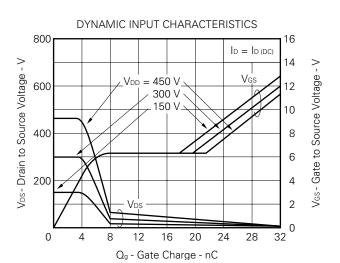


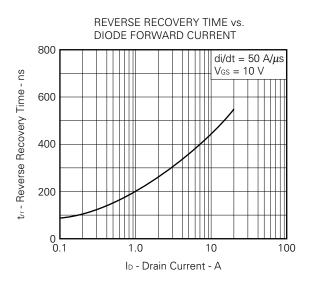


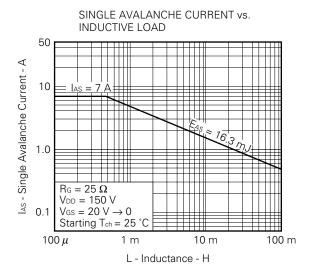




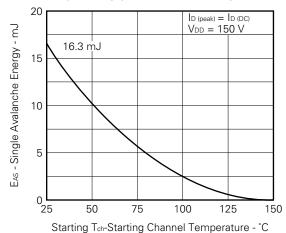








## SINGLE AVALANCHE ENERGY vs. STARTING CHANNEL TEMPERATURE



#### **REFERENCE**

Document Name	Document No.
NEC semiconductor device reliability/quality control system.	TEI-1202
Quality grade on NEC semiconductor devices.	IEI-1209
Semiconductor device mounting technology manual.	IEI-1207
Semiconductor device package manual.	IEI-1213
Guide to quality assurance for semiconductor devices.	MEI-1202
Semiconductor selection guide.	MF-1134
Power MOS FET features and application switching power supply.	TEA-1034
Application circuits using Power MOS FET.	TEA-1035
Safe operating area of Power MOS FET.	TEA-1037

The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device is actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

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